

Vishay Semiconductors

Power MOSFET, 190 A



100 V

190 A

0.0065 Ω

Modules - MOSFET

SOT-227

PRODUCT SUMMARY

V_{DSS}

I_D DC

R_{DS(on)}

Type

Package

FEATURES

- · Fully isolated package
- Very low on-resistance
- · Fully avalanche rated
- Dynamic dV/dt rating
- · Low drain to case capacitance
- · Low internal inductance
- Optimized for SMPS applications
- · Easy to use and parallel
- · Industry standard outline
- Compliant to RoHS Directive 2002/95/EC
- · Designed and gualified for industrial level

DESCRIPTION

High current density power MOSFETs are paralleled into a compact, high power module providing the best combination of switching, ruggedized design, very low on-resistance and cost effectiveness.

The isolated SOT-227 package is preferred for all commercial-industrial applications at power dissipation levels to approximately higher than 500 W. The low thermal resistance and easy connection to the SOT-227 package contribute to its universal acceptance throughout the industry.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
	Ι _D	T _C = 40 °C	190		
Continuous drain current at V_{GS} 10 V		T _C = 100 °C	130	А	
Pulsed drain current	I _{DM}		720	1	
Power dissipation	PD	T _C = 25 °C	568	W	
Linear derating factor			2.7	W/°C	
Gate to source voltage	V _{GS}		± 20	V	
Single pulse avalanche energy	E _{AS} ⁽²⁾		700	mJ	
Avalanche current	I _{AR} ⁽¹⁾		180	А	
Repetitive avalanche energy	E _{AR} ⁽¹⁾		48	mJ	
Peak diode recovery dV/dt	dV/dt ⁽³⁾		5.7	V/ns	
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C	
Insulation withstand voltage (AC-RMS)	V _{ISO}		2.5	kV	
Mounting torque		M4 screw	1.3	Nm	

Notes

⁽¹⁾ Repetitive rating; pulse width limited by maximum junction temperature.

 $^{(2)}$ Starting T_J = 25 °C, L = 43 $\mu H,~R_g$ = 25 $\Omega,~I_{AS}$ = 180 A.

⁽³⁾ $I_{SD} \le 180$ A, dl/dt ≤ 83 A/µs, $V_{DD} \le V_{(BR)DSS}$, $T_J \le 150$ °C.

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THERMAL RESISTANCE						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	
Junction to case	R _{thJC}	-	-	0.22	°C/W	
Case to heatsink, flat, greased surface	R _{thCS}	-	0.05	-		

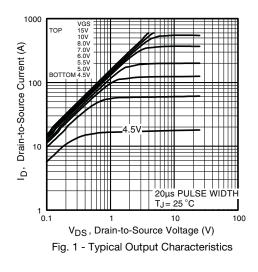
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain to source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100	-	-	V
Breakdown voltage temperature coefficient	$\Delta V_{(BR)DSS} / \Delta T_J$	Reference to 25 °C, I _D = 1 mA	-	0.093	-	V/°C
Static drain to source on-resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 180 \text{ A}$	-	0.0054	0.0065	Ω
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.0	3.3	4.35	V
Forward transconductance	9 _{fs}	V _{DS} = 25 V, I _D = 180 A	93	-	-	S
Drain to source leakage current		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	50	μA
	IDSS	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$	-	-	500	
Gate to source forward leakage	I _{GSS}	V _{GS} = 20 V	-	-	200	nA
		V _{GS} = - 20 V	-	-	- 200	
Total gate charge	Qg	I _D = 180 A V _{DS} = 80 V	-	250	-	nC
Gate to source charge	Q _{gs}		-	40	-	
Gate to drain ("Miller") charge	Q _{gd}	V _{GS} = 10 V	-	110	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 50 V	-	45	-	
Rise time	t _r	$I_{\rm D} = 180 \rm{A}$	-	351	-	
Turn-off delay time	t _{d(off)}	$R_g = 2.0 \Omega$ (internal)	-	181	-	ns
Fall time	t _f	R _D = 0.27 Ω	-	335	-	1
Internal source inductance	L _S	Between lead, and center of die contact	-	5.0	-	nH
Input capacitance	C _{iss}	$V_{GS} = 0 V$	-	10 700	-	
Output capacitance	C _{oss}	$V_{DS} = 25 V$	-	2800	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz	-	1300	-	1

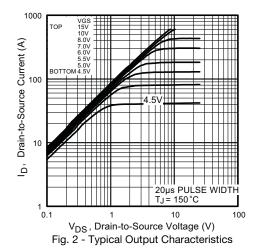
SOURCE-DRAIN RATINGS AND CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Continuous source current (body diode)	I _S	MOSFET symbol showing the integral	-	-	190	A
Pulsed source current (body diode)	I _{SM}	reverse p-n junction diode.	-	-	740	A
Diode forward voltage	V _{SD}	T_J = 25 °C, I_S = 180 A, V_{GS} = 0 V	-	1.0	1.3	V
Reverse recovery time	t _{rr}	T_J = 25 °C, I_F = 180 A, dI/dt = 100 A/ μs	-	300	-	ns
Reverse recovery charge	Q _{rr}		-	2.6	-	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by $L_{S} + L_{D}$)				

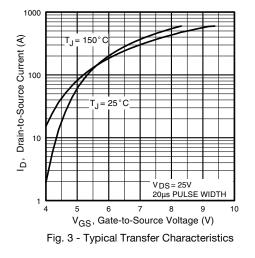


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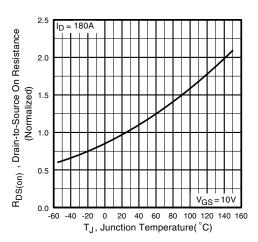
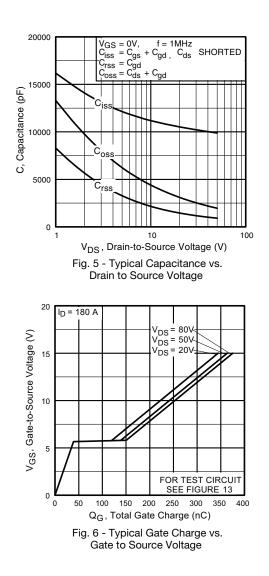


Fig. 4 - Normalized On-Resistance vs. Temperature



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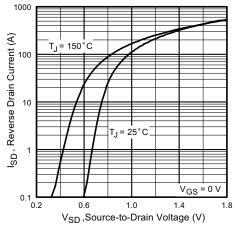
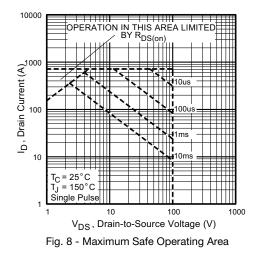
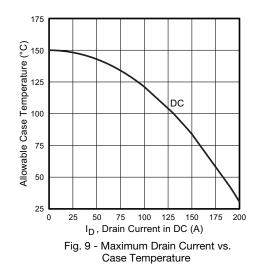
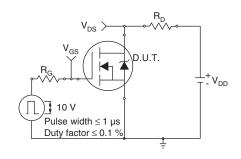
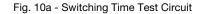


Fig. 7 - Typical Source Drain Diode Forward Voltage









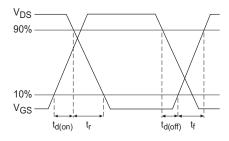


Fig. 10b - Switching Time Waveforms

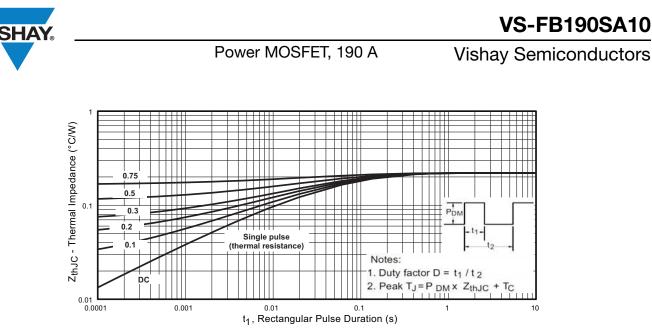


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction to Case

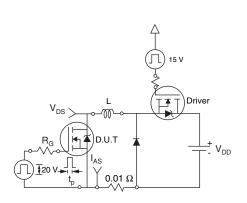


Fig. 12a - Unclamped Inductive Test Circuit

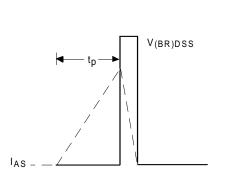


Fig. 12b - Unclamped Inductive Waveforms

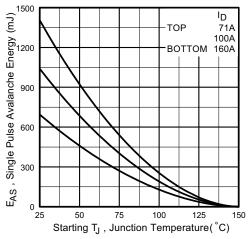


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

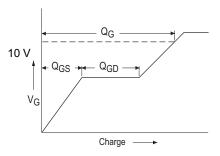


Fig. 13a - Basic Gate Charge Waveform

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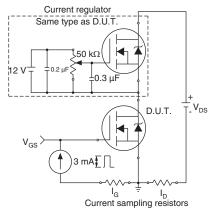


Fig. 13b - Gate Charge Test Circuit

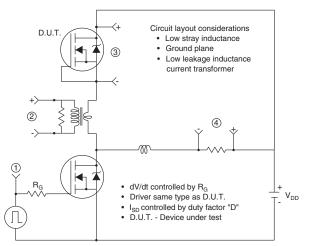
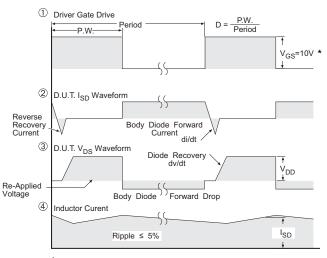


Fig. 13c - Peak Diode Recovery dV/dt Test Circuit



* V_{GS} = 5V for Logic Level Devices

Fig. 14 - For N-Channel Power MOSFETs

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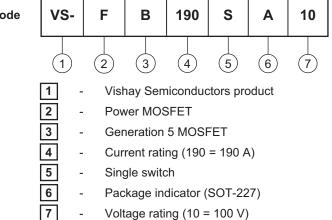


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ORDERING INFORMATION TABLE

Device code



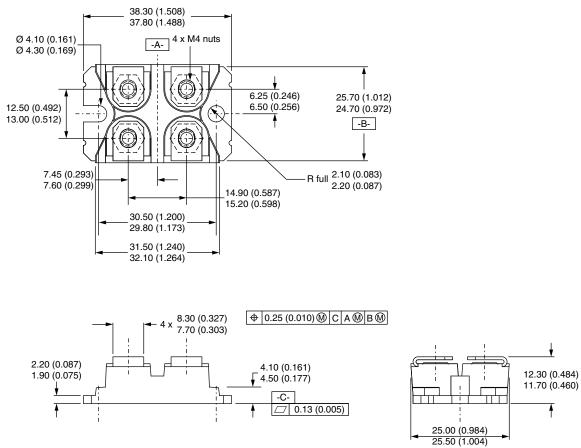
CIRCUIT CONFIGURATION				
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING		
Single switch	S	Lead Assignment () () () () () () () () () ()		

LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?95423				
Packaging information	www.vishay.com/doc?95425			

Vishay Semiconductors



SOT-227 Generation II



DIMENSIONS in millimeters (inches)

Note

· Controlling dimension: millimeter

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